502575379 11/20/2013

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2621303

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHUHEI TATEMICHI	10/25/2013
TAKEYOSHI NISHIMURA	10/25/2013
YASUSHI NIIMURA	10/25/2013
MASANORI INOUE	10/25/2013

RECEIVING PARTY DATA

Name:	FUJI ELECTRIC CO., LTD.
Street Address:	1-1 TANABESHINDEN, KAWASAKI-KU,
City:	KAWASAKI-SHI
State/Country:	JAPAN
Postal Code:	210-9530

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14054277

CORRESPONDENCE DATA

Fax Number: (202)408-0924 Phone: 202-371-8976 Email: firm@rabinberdo.com

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: RABIN & BERDO, PC Address Line 1: 1101 14TH STREET, NW

Address Line 2: SUITE 500

Address Line 4: WASHINGTON, DISTRICT OF COLUMBIA 20005

ATTORNEY DOCKET NUMBER:	FEC-514
NAME OF SUBMITTER:	ROBERT H. BERDO, JR.

REEL: 031635 FRAME: 0835

PATENT

Signature:	/Robert H. Berdo, Jr./	
Date:	11/20/2013	
	This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 2 source=ASSIGNMENT_14054277#page1.tif source=ASSIGNMENT_14054277#page2.tif		

PATENT REEL: 031635 FRAME: 0836 8/12 Attorney Reference: FEC-514

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS Shuhei TATEMICHI, Takeyoshi NISHIMURA, Yasushi NIIMURA, Masanori INOUE,

hereinafter referred to collectively as the assignor and inventor, has invented a certain improvement relating to

SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE

<u>DE</u>	YICE
[] said application being attached hereto; [x] said application having been filed in the United State Application Serial No. <u>14/054,277</u> , and was ame [] the specification of which was filed under the Patent Serial No, the United States of An	Cooperation Treaty on
AND WHEREAS <u>FUJI ELECTRIC CO., LTD.,</u> hereinafter referred to as the assignee or applicant, is dand to said application, including any and all divisions around all patents which may be granted therefor, including any and all patents which may be granted therefor, including the said and all patents which may be granted therefor, including the said and all patents which may be granted therefor, including the said and said a	estrous of acquiring the entire right, title and interest in nd continuations thereof, and in and to said invention and
valuable consideration paid by said assignee to said as assignor hereby assigns, sells and transfers to said as full and exclusive right, title and interest in and to continuations thereof, and in and to said invention a including any and all renewals, reissues and profo successors and assigns, to have, hold, exercise and en continuations thereof, and the said invention and any ar and all renewals, reissues and prolongations thereof, anywise arising from or appertaining thereto, for and d granted, including any and all renewals, reissues and	consideration of One Dollar (\$1.00), and other good and signor, the receipt of which is hereby acknowledged, said signee, and said assignee's successors and assigns, the said application, including any and all divisions and and any and all patents which may be granted therefor, orgations thereof; said assignee, and said assignee's joy the said application, including any and all divisions and all patents which may be granted therefor, including any with all the rights, powers, privileges and advantages in uring the term or terms of any and all such patents when a prolongations thereof, for the use and benefit of said in as ample and beneficial a manner as the said assignor assignment had not been made.
	, upon the request of said assignee, or said assignee's obtaining or to the asserting of said patents, including any
AND said assignor authorizes and requests the Letters Patent on said application, and on any and all controls assignee's successors and assigns, in accordance	the Commissioner of Patents and Trademarks to issue divisions and continuations thereof, to said assignee, and herewith.
	are that the above-identified application was made or inventor or an original joint inventor of a claimed invention
I hereby acknowledge that any willful false sta U.S.C. 1001 by fine or imprisonment of not more than fin	atement made in this declaration is punishable under 18 ve (5) years, or both.
Address all correspondence and telephone cal 500, Washington, D.C. 20005, Telephone: (202) 371-89	ls to Rabin & Berdo, P.C., 1101 14 th Street, N.W., Suite 76; Fax: (202) 408-0924, Customer No. 23995.
WITNESS:	ASSIGNOR (SOLE OR FIRST INVENTOR):
Signature:	Signature: Shuker Tatomichi
Name:	Legal Name: Shuhei TATEMICHI
Address:	Date: <u>October</u> 25, 2013

RABIN & BERDO, P.C., Washington, D.C.

PATENT REEL: 031635 FRAME: 0837

Continued – Page 2 ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

WITNESS:	ASSIGNOR (SECOND INVENTOR):
Signature:	Signature: Takejoska Nithingra
Name:	Legal Name: <u>Takeyoshi NISHIMURA</u>
Address:	Date: Tokogood Richiones a Artiler 25 20/3
WITNESS:	ASSIGNOR (THIRD INVENTOR):
Signature:	Signature: <u>Yasushi Mumura</u>
Name:	Legal Name: Yasushi NIIMURA
Address:	Date: October, 25 20/3
WITNESS:	ASSIGNOR (FOURTH INVENTOR):
Signature:	Signature: Majangri Ingua
Name:	Legal Name: Masanori INOUE
Address:	Date: <u>Goden, 25, 20/3</u>

RABIN & BERDO, P.C., Washington, D.C.

RECORDED: 11/20/2013

PATENT REEL: 031635 FRAME: 0838